

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1-10. (Cancelled)

11. (Previously Presented) A three-dimensional mounted assembly comprising:
a molded body;

a plurality of electronic parts sealed with the molded body; and

an interconnection sealed with the molded body,

wherein the interconnection has its first exposed end facing outside the molded body, the first exposed end and a first side of the molded body being on the same first plane, the first exposed end not extending beyond the first plane, and

wherein the interconnection has its second exposed end facing outside the molded body, the second exposed end and a second side of the molded body differing from the first side being on the same second plane and the second exposed end not extending beyond the second plane.

12-16. (Cancelled)

17. (Original) The three-dimensional mounted assembly as defined in claim 11, wherein each of the electronic parts is an optical device, and a hole linking an optical section of the optical device is formed in the molded body.

18. (Original) The three-dimensional mounted assembly as defined in claim 17, wherein an optical fiber is inserted into the hole to form an optical module.

19. (Original) An optical transmission device comprising:

a plurality of the three-dimensional mounting assemblies as defined in claim 17; and
an optical fiber connected to each of the three-dimensional mounting assemblies.

20. (Original) The optical transmission device as defined in claim 19, further comprising a plug electrically connected to each of the three-dimensional mounting assemblies.

21. (Previously Presented) A three-dimensional mounted assembly comprising:
a molded body, the molded body having a first side formed by a first mold, the molded body having a second side formed by a second mold;
a plurality of electronic parts sealed with the molded body; and
an interconnection sealed with the molded body,
wherein the interconnection has its first exposed end facing outside the molded body and formed by the first mold on a first side of the molded body such that the first exposed end and the first side of the molded body are on the same first plane and the first exposed end does not extend beyond the first plane, and

wherein the interconnection has its second exposed end facing outside the molded body and formed by the second mold on a second side of the molded body differing from the first side such that the second exposed end and the second side of the molded body are on the same second plane and the second exposed surface does not extend beyond the second plane.